

BPIX Module Testing Status - week 50

5th January 2007

Production overview

Production Status: 308 modules produced

- 213/40 graded as A/B → 82%
- 55 graded as C → 18%

Testing Status of week 50:

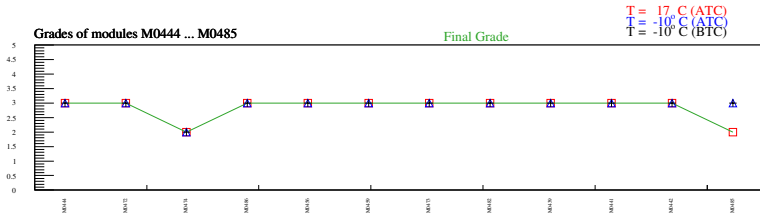
- 12 modules fully tested and therm. cycled

Grade	A	B	C
T = -10° C, BTC*	11	1	0
T = -10° C, ATC	11	1	0
T = $+17^{\circ}$ C, ATC	10	2	0
Final Grade	10	2	0

- 3 partially tested / testing failed
- no retests

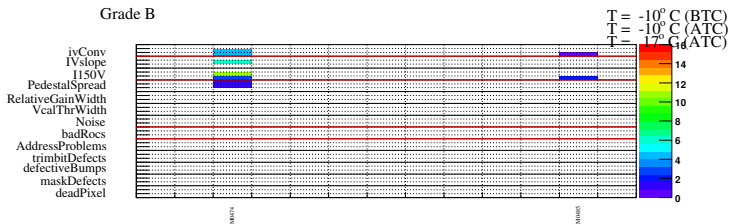
*without IV-criteria

Production summary

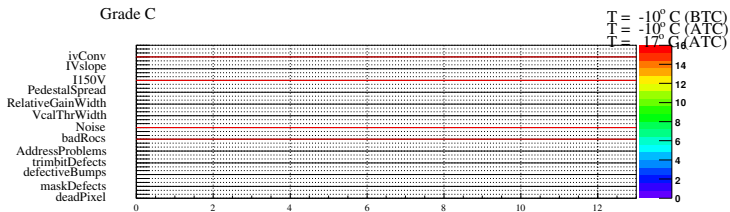


Module Failures Overview

Grade B

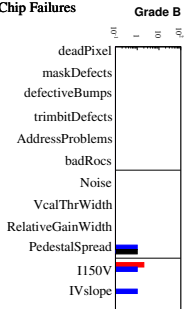


Grade C



Grade B

Chip Failures

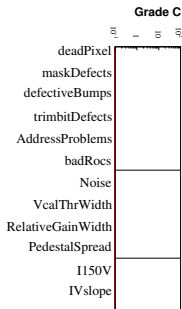


T = 17° C (ATC)

T = -10° C (ATC)

T = -10° C (BTC)

Grade C Failures



← Pixel defects

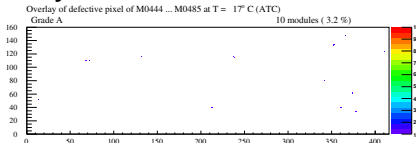
← Chip performance

← Module IV

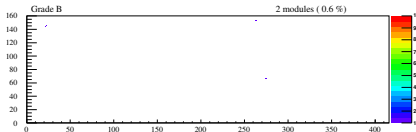
Defective pixel $T = 17^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = +17^{\circ}\text{C}$ (ATC)

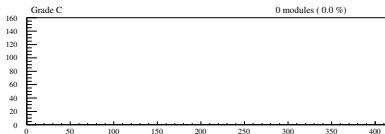
Grade A
(10 modules)



Grade B
(2 modules)



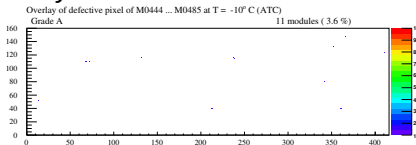
Grade C
(0 modules)



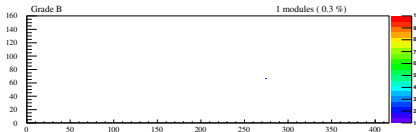
Defective pixel $T = -10^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = -10^{\circ}\text{C}$ (ATC)

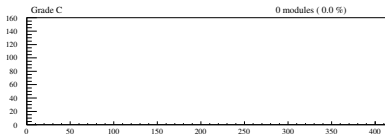
Grade A
(11 modules)



Grade B
(1 modules)



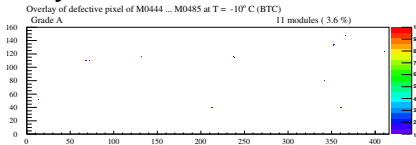
Grade C
(0 modules)



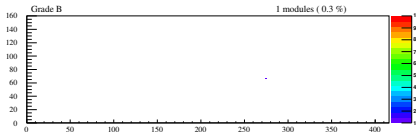
Defective pixel $T = -10^{\circ}\text{C}$ (BTC)

Overlay of all fully tested modules at $T = -10^{\circ}\text{C}$ (BTC)

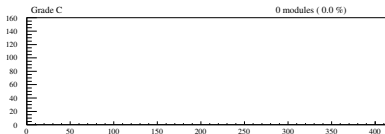
Grade A
(11 modules)



Grade B
(1 modules)



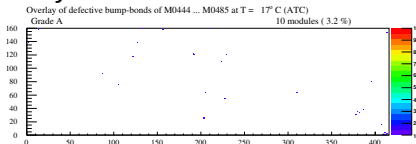
Grade C
(0 modules)



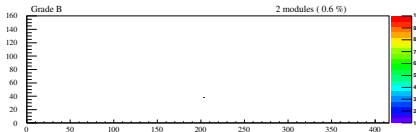
Defective bump-bonds $T = 17^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = +17^{\circ}\text{C}$ (ATC)

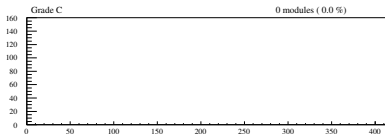
Grade A
(10 modules)



Grade B
(2 modules)



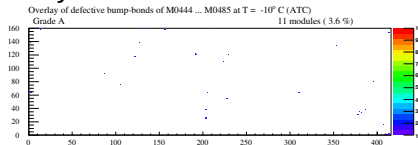
Grade C
(0 modules)



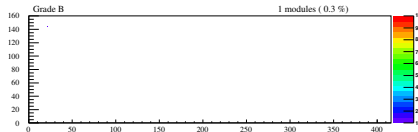
Defective bump-bonds $T = -10^{\circ}\text{C}$ (ATC)

Overlay of all fully tested modules at $T = -10^{\circ}\text{C}$ (ATC)

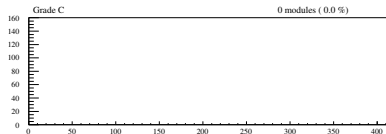
Grade A
(11 modules)



Grade B
(1 modules)



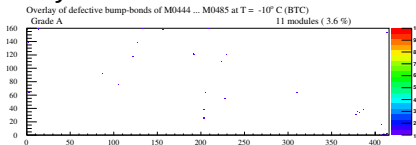
Grade C
(0 modules)



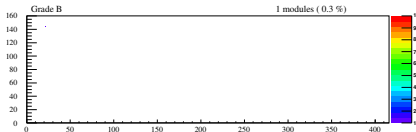
Defective bump-bonds $T = -10^{\circ}\text{C}$ (BTC)

Overlay of all fully tested modules at $T = -10^{\circ}\text{C}$ (BTC)

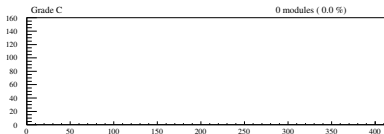
Grade A
(11 modules)



Grade B
(1 modules)



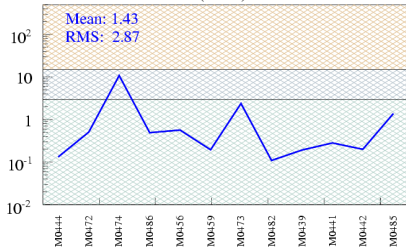
Grade C
(0 modules)



Current at 150 V

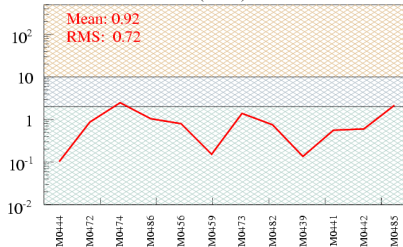
Current at 150 V (in μA) at $T = 17^\circ\text{C}$ and $T = -10^\circ\text{C}$

I150V at $T = -10^\circ\text{C}$ (ATC)



recalculated

I150V at $T = 17^\circ\text{C}$ (ATC)

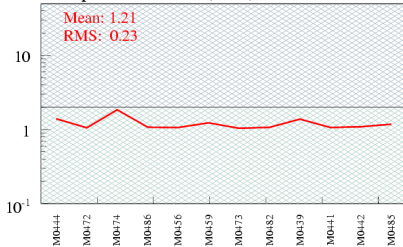


measured

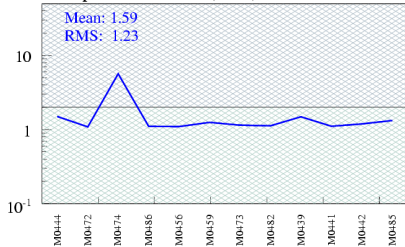
Slope of IV-Curve

Slope of IV-Curve at $T = 17^{\circ}\text{C}$ and $T = -10^{\circ}\text{C}$

IVslope at $T = 17^{\circ}\text{C}$ (ATC)



IVslope at $T = -10^{\circ}\text{C}$ (ATC)

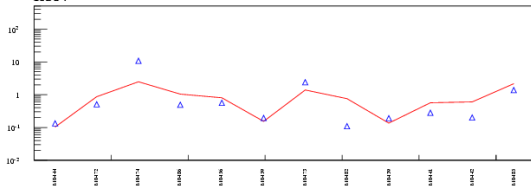


Current recalculation to $T = 17^{\circ}\text{C}$

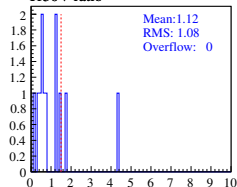
Cross check of recalculated values with measured values

$T = 17^{\circ}\text{C}$ (ATC)
 $T = -10^{\circ}\text{C}$ (ATC)
 $T = -10^{\circ}\text{C}$ (BTC)

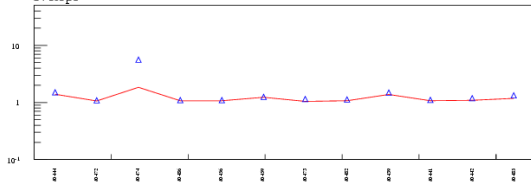
I150V



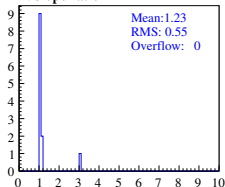
I150V ratio



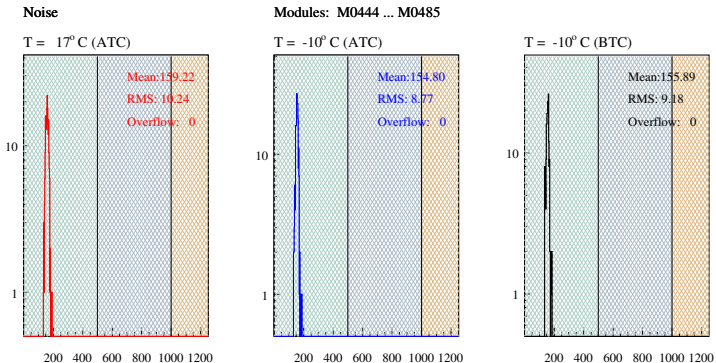
IVslope



IVslope ratio

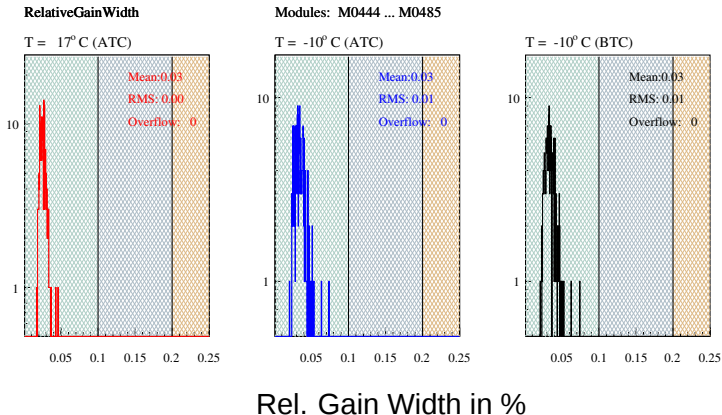


MeanNoise of chips

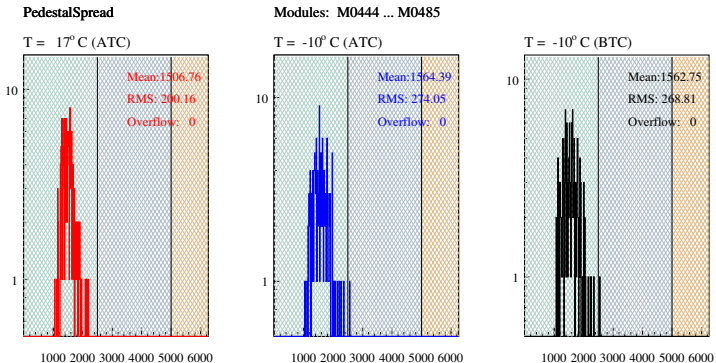


Noise in e^-

RelativeGainWidth of chips



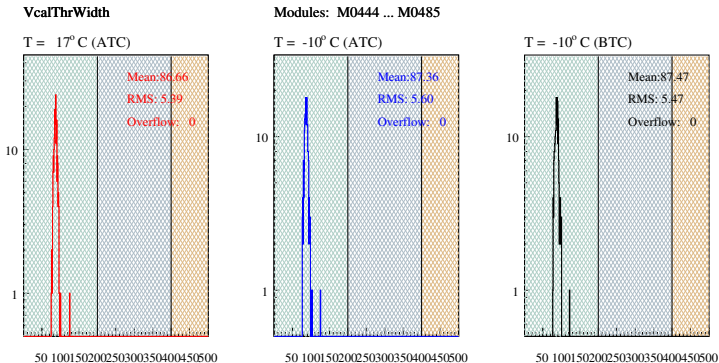
PedestalSpread of chips



Pedestal Spread in e^-

Vcal Threshold Width

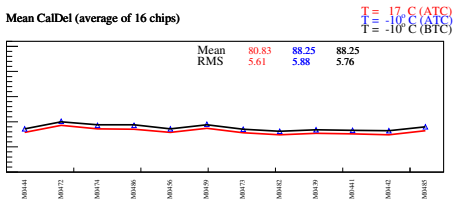
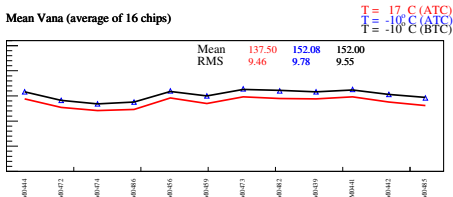
VcalThresholdWidth of chips



Vcal Thr. Width in e^-

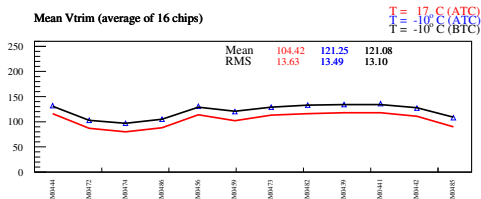
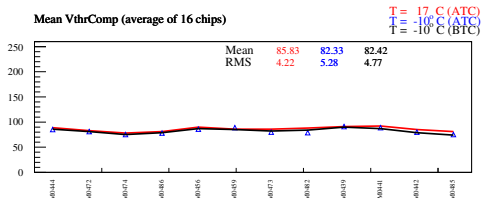
Operational parameters I

Mean DACs I



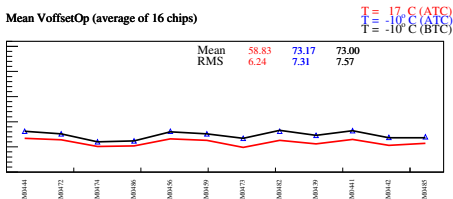
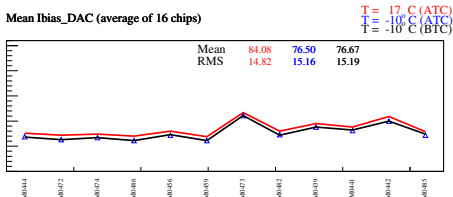
Operational parameters II

Mean DACs II



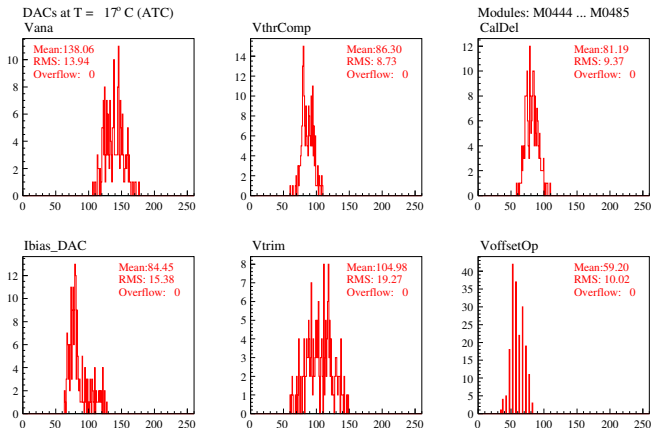
Operational parameters III

Mean DACs III



Operational parameters at $T = +17^{\circ}\text{C}$ (ATC)

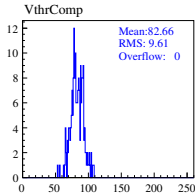
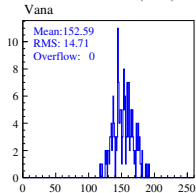
DAC distribution (of chips)



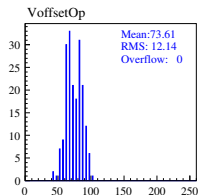
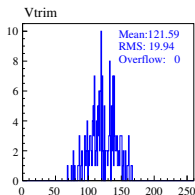
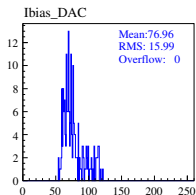
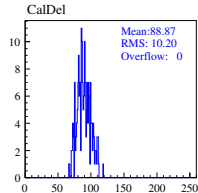
Operational parameters at $T = -10^{\circ}\text{C}$ (ATC)

DAC distribution (of chips)

DACs at $T = -10^{\circ}\text{C}$ (ATC)



Modules: M0444 ... M0485



Operational parameters at $T = +17^{\circ}\text{C}$ (BTC)

DAC distribution (of chips)

